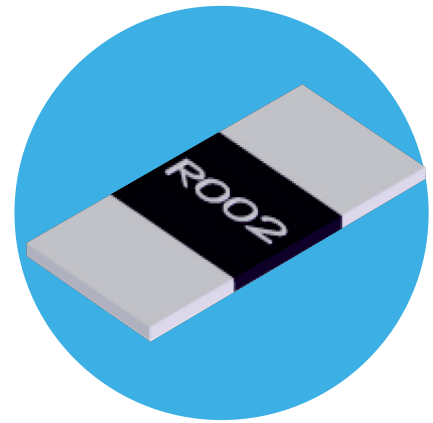


Low Resistance Metal Alloy Resistor

LRMA Series

- Resistance range 0.5mΩ to 300mΩ
- High temperature operation to 170°C
- Low thermal EMF version
- High power version
- Current sensing for power electronics
- RoHS compliant & halogen free
- AEC-Q200 qualified



All parts are Pb-free and comply with EU Directive 2011/65/EU (RoHS2)

Electrical Data

| LRMA Version | Size | T (Standard) | | P (Power) |
|------------------------------|--------|---------------------------|---|--|
| | | 2010 | 2512 | 2512 |
| Power rating @70°C | W | 1.5 | ≤R01: 2, >R01: 1 | ≤R10: 3, >R10: 2 |
| Overload rating (5s) | W | 7.5 | ≤R01: 10, >R01: 5 | ≤R10: 15, >R10: 10 |
| Resistance range | mΩ | 5 to 100 | 1 to 100 | 0.5 to 300 |
| Standard values ¹ | mΩ | 5, 6, 10, 15, 20, 50, 100 | 1, 1.5, 2, 3, 3.5, 4, 5, 6, 7, 8, 10, 11, 12, 15, 18, 20, 25, 30, 33, 35, 40, 50, 100 | 0.5, 0.75, 1, 1.1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 15, 18, 20, 22, 25, 27, 30, 33, 39, 40, 45, 47, 50, 57, 60, 68, 70, 75, 80, 85, 90, 100, 120, 130, 140, 150, 180, 200, 220, 240, 250, 270, 280, 300 |
| Resistance tolerance | % | 1, 5 | | |
| TCR (25 to 125°C) | ppm/°C | ≥R01: ±75 | >R001 & <R01: ±100, ≤R001: ±275 | ±50 |
| Ambient temperature | °C | -55 to 170 | | |
| Insulation resistance | MΩ | >100 | | |
| Element alloy | | Cu-Ni | | Cu-Ni / Mn-Cu |
| Coating | | Black | | |

| LRMA Version | Size | M (Low thermal EMF) | | | N (Inverse) | |
|------------------------------|--------|------------------------|--|--|----------------|-----------------------------|
| | | 0805 | 1206 | 2512 | 0612 | 0815 |
| Power rating @70°C | W | 0.5 | 1 | ≤R01: 2, >R01: 1 | 1 ² | |
| Overload rating (5s) | W | 2.5 | 5 | ≤R01: 10, >R01: 5 | 5 | |
| Resistance range | mΩ | 5 to 25 | 1 to 50 | 0.5 to 60 | 1 to 3 | 3 to 30 |
| Standard values ¹ | mΩ | 5, 6, 8, 9, 10, 20, 25 | 1, 1.2, 2, 3, 4, 5, 6, 7, 8, 9, 10, 12, 14, 15, 18, 20, 22, 25, 30, 39, 40, 50 | 0.5, 0.75, 1, 1.5, 2, 3.5, 5, 10, 20, 25, 30, 40, 50, 60 | 1, 3 | 3, 4, 5, 10, 15, 20, 25, 30 |
| Resistance tolerance | % | 1, 5 | | | | |
| TCR (25 to 125°C) | ppm/°C | ±100 | ±50 | ≥R01: ±75, >R001 & <R01: ±100 ≤R001: ±275 | ±100 | |
| Ambient temperature | | -55 to 170°C | | | | |
| Insulation resistance | MΩ | >100 | | | | |
| Element alloy | | Mn-Cu | | | Mn-Cu / Cu-Ni | |
| Coating | | Black | | Green | Black | |

Notes: 1. Non-standard values may be available for high volume requirements. 2. Requires 300mm² copper pad & trace area

Physical Data (All dimensions in mm and nominal weight in mg)

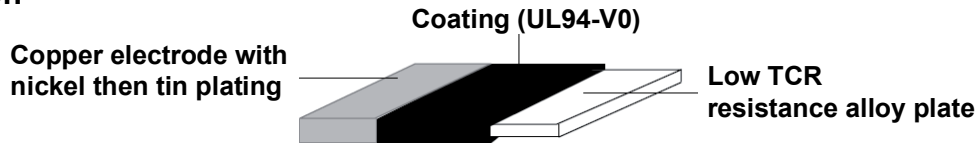
| Size | L | W | C | t | Wt |
|--------------------|-----------|-----------|----------|------------|----------|
| 0805 | 2.0 ±0.1 | 1.25 ±0.1 | 0.4 ±0.2 | 0.6 ±0.2 | 5.5 |
| 1206 <R002 | 3.2 ±0.2 | 1.6 ±0.2 | 1.1 ±0.3 | 0.75 ±0.2 | 18.3 |
| 1206 ≥R002 | | | 0.5 ±0.3 | 0.6 ±0.2 | |
| 0612 | 1.7 ±0.2 | 3.2 ±0.2 | 0.4 ±0.2 | 0.6 ±0.2 | 12.9 |
| 0815 | 2.1 ±0.25 | 3.75 ±0.3 | 0.5 ±0.2 | 0.7 ±0.2 | 14.1 |
| 2010 | 5.0 ±0.2 | 2.5 ±0.2 | 0.6 ±0.3 | 0.6 ±0.2 | 35.6 |
| 2512 <R001 | 6.4 ±0.2 | 3.2 ±0.2 | 2.6 ±0.2 | 0.65 ±0.25 | 57 to 63 |
| 2512 ≥R001 & ≤R003 | | | 2.0 ±0.2 | | |
| 2512 >R003 | | | 0.9 ±0.2 | | |

General Note

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LRMA Series

Construction



Marking

The components are marked with ohmic value, e.g. "R002" = 2mΩ, "R010" = 10 mΩ.
Due to space restrictions, for LRMAM1206-R001, "01" = 1mΩ is used, and for LRMAM0805, "002" = 2mΩ, "010" = 10 mΩ are used.

Solvent Resistance

The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

Performance Data

| | | Maximum (%) | Typical (%) |
|---|-----|----------------------|-------------|
| Load at rated power (cyclic load, 1000 hours at 70°C) | ±ΔR | 0805: 1.5 Others 1 | 0.3 |
| Short term overload (5 x rated power for 5s) | ±ΔR | 0.5 | 0.15 |
| Humidity (1000 hours, 85°C, 85%RH) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Temperature cycle (-40 to +125°C, 1000 cycles, 15 minute dwell) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Resistance to solder heat (260°C ±5°C for 20s ±1s) | ±ΔR | 0.5 | 0.3 |
| Solderability (245°C ±5°C for 2s ±0.5s) | | >95% coverage | |
| Dry heat (1000 hours at 170°C) | ±ΔR | 0805: 1.5 Others 0.5 | 0.3 |
| Low temperature storage (1000 hours at -55°C) | ±ΔR | 0.5 | 0.15 |
| Substrate bending (board 1.6mm, fulcrum spacing 90mm, deflection 2mm) | ±ΔR | 0805: 1 Others 0.5 | 0.3 |
| Insulation resistance (1 minute @ 100Vdc) | | >100M | |

Thermal Performance & Mounting

Temperature Derating

Typical Temperature Rise

Reference Pad Dimensions (mm)

| Size | a | b | L |
|------------------|-----|------|-----|
| 0612 | 3.8 | 0.7 | 0.7 |
| 0805 | 1.4 | 1.15 | 1.2 |
| 1206 \leq R002 | 1.8 | 2.3 | 1.0 |
| 1206 \geq R002 | 1.8 | 1.7 | 1.6 |
| 0815 | 7.9 | 1.5 | 0.9 |
| 2010 | 3.4 | 1.5 | 3.5 |
| 2512 \leq R003 | 4.0 | 3.1 | 1.3 |
| 2512 $>$ R003 | 4.0 | 2.1 | 4.1 |

Current Sense

The temperature rise shown is highly dependent on mounting conditions. Reference conditions assume 20μ copper with thermal vias to multiple layers. The self-heating in the current tracks should be kept negligible, or allowed for by temperature derating.

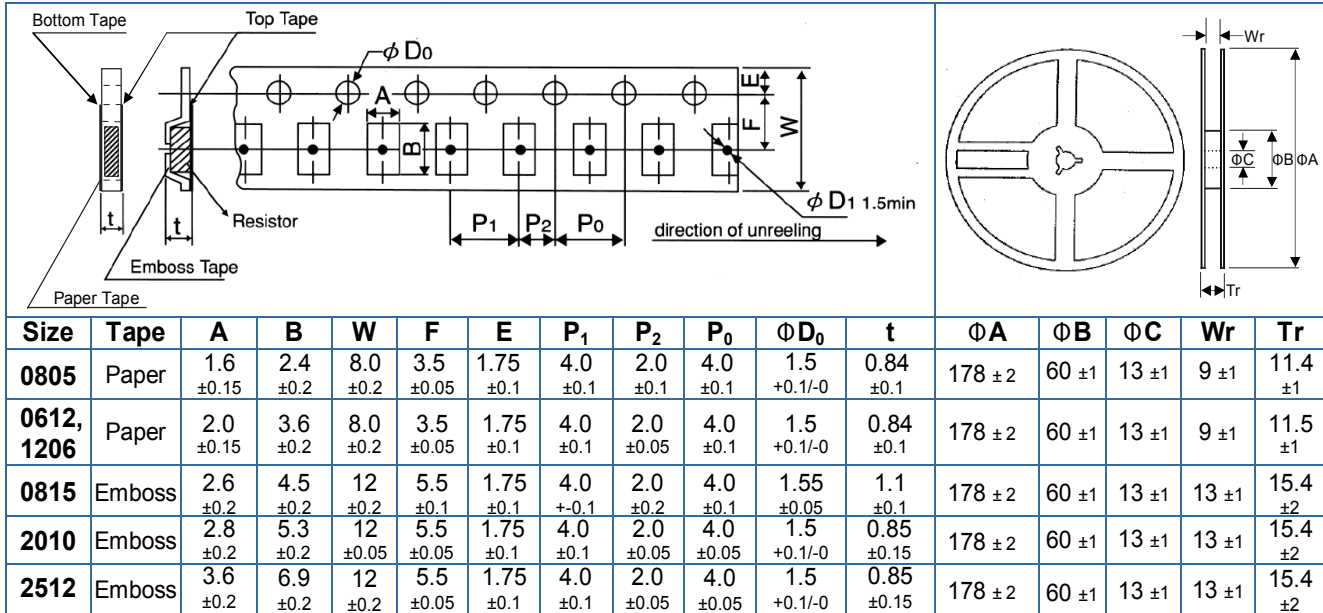
Standard 4-terminal probe pitches for measuring unmounted parts are 2.8 x 1.7mm (0612), 0.4 x 1.83mm (0805) 0.4 x 2.8mm (1206), 1.2 x 4.5mm (2010) and 1.5 x 5.8mm (2512). All probe location tolerances ±0.02mm.

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LRMA Series

Packaging



Storage

Conditions: 5°C to 35°C and 40% to 75%RH
Shelf life: 2 years from manufacture

Processing

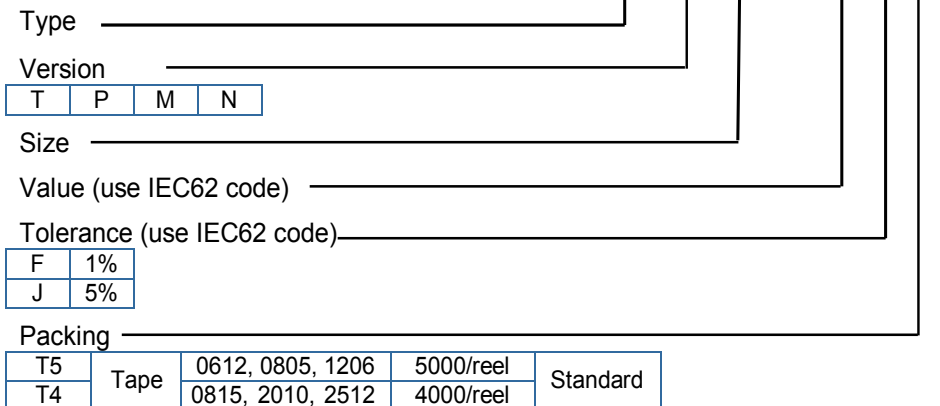
LRMA series resistors are suitable for both wave and IR reflow soldering. The recommended reflow profile for Pb-free SAC305 alloy (Sn 96.5%, Ag 3%, Cu 0.5%) soldering is as follows:

Pre-heat: 60s to 120s at 150°C to 180°C
Soldering: 20s to 40s at ≥230°C
Peak: 5s at 250°C to 255°C

Ordering Procedure

Example: LRMA low thermal EMF version in 2512 size and at 10 milliohms and 1% tolerance packed in tape.

LRMAM2512-1R01FT4



Note 1: For values which require 6 characters, e.g. R00075, the hyphen is omitted.

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